

3SK234

Silicon N Channel Dual Gate MOS FET
VHF TV Tuner RF Amplifier

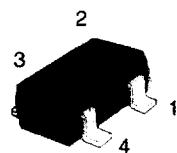
Features

- Low voltage operation.
- Superior cross modulation characteristics.

Table 1 Absolute Maximum Ratings
(Ta = 25°C)

Item	Symbol	Rating	Unit
Drain to source voltage	V _{DS}	12	V
Gate 1 to source voltage	V _{G1S}	±10	V
Gate 2 to source voltage	V _{G2S}	±10	V
Drain current	I _D	35	mA
Channel power dissipation	P _{ch}	150	mW
Channel temperature	T _{ch}	125	°C
Storage temperature	T _{stg}	-55 to +125	°C

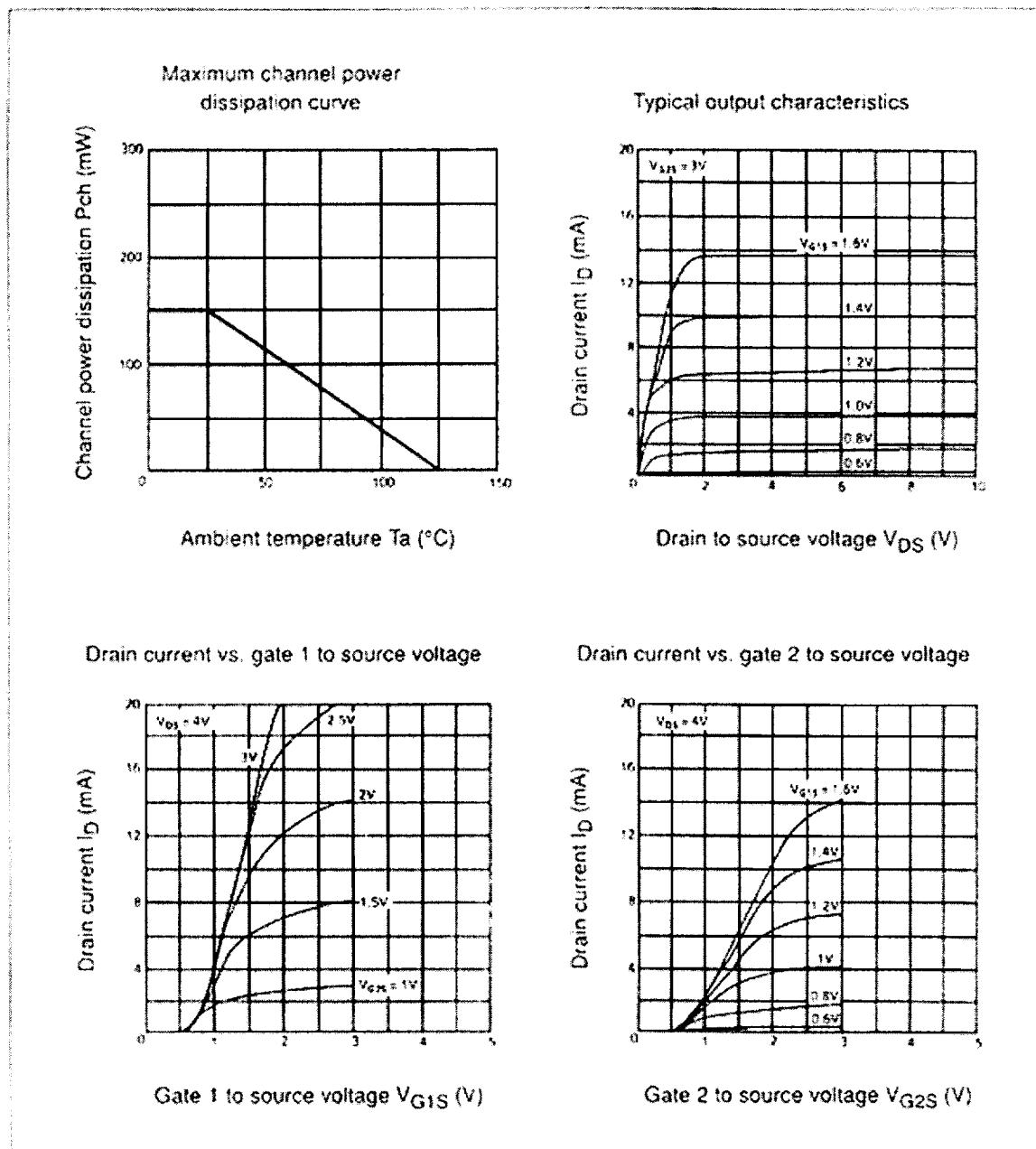
MPAK-4

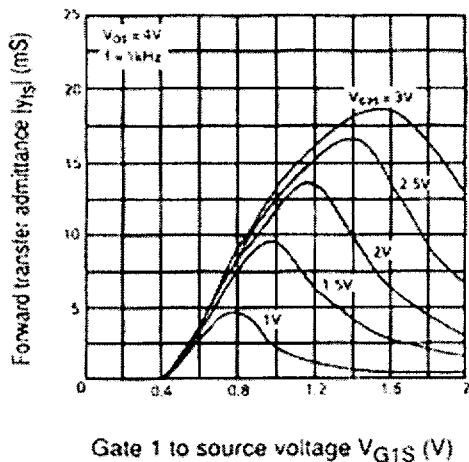


1. Source
2. Gate 1
3. Gate 2
4. Drain

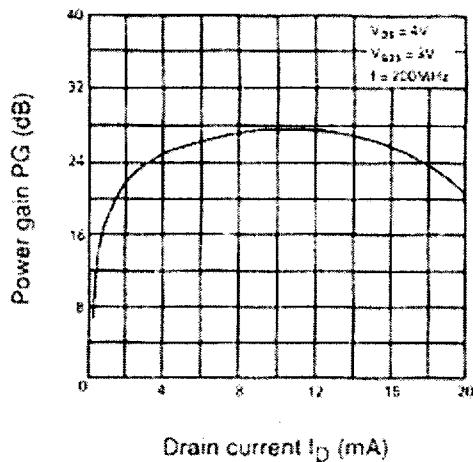
3SK234**Table 2 Electrical Characteristics (Ta = 25°C)**

Item	Symbol	Min	Typ	Max	Unit	Test condition
Drain to source breakdown voltage	V _{(BR)DSX}	12	—	—	V	I _D = 200 μA, V _{G1S} = -5 V, V _{G2S} = -5 V
Gate 1 to source breakdown voltage	V _{(BR)G1SS}	±10	—	—	V	I _{G1} = ±10 μA, V _{G2S} = V _{DS} = 0
Gate 2 to source breakdown voltage	V _{(BR)G2SS}	±10	—	—	V	I _{G2} = ±10 μA, V _{G1S} = V _{DS} = 0
Gate 1 cutoff current	I _{G1SS}	—	—	±100	nA	V _{G1S} = ±8 V, V _{G2S} = V _{DS} = 0
Gate 2 cutoff current	I _{G2SS}	—	—	±100	nA	V _{G2S} = ±8 V, V _{G1S} = V _{DS} = 0
Drain current	I _{DSS}	0	—	1	mA	V _{DS} = 4 V, V _{G1S} = 0, V _{G2S} = 3 V
Gate 1 to source cutoff voltage	V _{G1S(off)}	0	—	+1.0	V	V _{DS} = 6 V, V _{G2S} = 3 V, I _D = 100 μA
Gate 2 to source cutoff voltage	V _{G2S(off)}	0	—	+1.0	V	V _{DS} = 6 V, V _{G1S} = 3 V, I _D = 100 μA
Forward transfer admittance	y _{fs}	13	17	—	mS	V _{DS} = 6 V, V _{G2S} = 3 V, I _D = 10 mA, f = 1 kHz
Input capacitance	C _{iss}	2.5	3.5	4.5	pF	V _{DS} = 6 V, V _{G2S} = 3 V, I _D = 10 mA, f = 1 MHz
Output capacitance	C _{oss}	1.0	1.4	1.8	pF	
Reverse transfer capacitance	C _{rss}	—	0.018	0.03	pF	
Power gain	PG	22	27.6	—	dB	V _{DS} = 4 V, V _{G2S} = 3 V, I _D = 10 mA, f = 200 MHz
Noise figure	NF	—	1.77	2.7	dB	



3SK234Forward transfer admittance
vs. gate 1 to source voltage

Power gain vs. drain current



Noise figure vs. drain current

